

N- and P-Channel 40 V (D-S) MOSFET

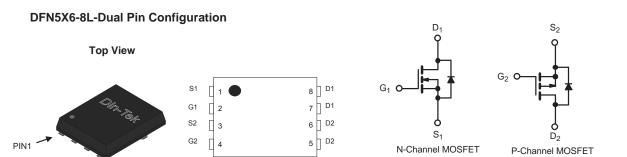
PRODUCT SUMMARY						
	$V_{DS}(V)$	R _{DS(on)} (mΩ) (Typ.)	I _D (A) ^a	Q _g (Typ.)		
N-Channel	40	5.8 at V _{GS} = 10 V	55	42.2 nC		
N-Channer		6.8 at V $_{ m GS}$ = 4.5 V	55			
P-Channel	- 40	9 at VGS = - 10 V	- 52	47 nC		
1 Ondriner		14 at VGS = - 4.5 V	- 52			

FEATURES

- DT-Trench Power MOSFET
- 100 % R_g and UIS tested
- Excellent Thermal Performance

APPLICATIONS

- Motor Drive
- DC-FAN



ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER		SYMBOL	N-Channel	P-Channel	UNIT	
Drain-Source Voltage	V _{DS}	40	- 40	V		
Gate-Source Voltage	V _{GS}	± 20	± 20	v		
Continuous Drain Current ($T_1 = 175^\circ C$) ^a	T _C = 25 °C	L	55	- 52		
$Continuous Drain Current (1) = 175^{\circ} C)^{-1}$	T _C = 100 °C	I _D	43	- 37	А	
Pulsed Drain Current ^b	I _{DM}	220	- 200			
Maximum Power Dissipation ^c	T _C = 25 °C	D-	45	34	W	
Maximum Fower Dissipation*	T _C = 100 °C	P _D	22.5	17	~~~	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175		°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	N-Channel	P-Channel	Unit		
	Symbol		Max Max			
Maximum Junction-to-Ambient ^d	R _{thJA}	50	60	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	3.33	4.4	C/VV		

Notes

a. Calculated continuous current based on maximum allowablejunction temperature.

b. Repetitive rating; pulse width limited by max. junction temperature.

c. Pd is based on max. junction temperature, using junction-case thermal resistance.

d. The value of ReJA is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with Ta=25 °C.

PARAMETER	SYMBOL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static	<u> </u>		<u> </u>	1	1		
Drain-Source Breakdown Voltage	V _{DS} V _{GS} = 0 V, I _D = 250 μA		40	-	-		
Gate Threshold Voltage	V _{GS(th)}	$V_{GS(th)}$ $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		-	3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 100	nA	
Zara Cata Valtaga Drain Current		V _{DS} = 40 V, V _{GS} = 0 V		-	1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 32 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$	-	-	100	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	55	-	-	Α	
Drain-Source On-State Resistance ^a	Р	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	5.8	8	mΩ	
Drain-Source On-State Resistance -	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	-	6.8	9.5		
Forward Transconductance ^a	g fs	$V_{DS} = 5 V, I_{D} = 10 A$	-	28	-	S	
Dynamic ^b				1	1		
Input Capacitance	C _{iss}		-	2250	-	pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 20 V, f = 1 MHz	-	162	-		
Reverse Transfer Capacitance	C _{rss}		-	139	-		
Total Gate Charge ^c	Qg		-	42.2	-		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 20 V, V_{GS} = 10 V, I_{D} = 10 A	-	4	-	nC	
Gate-Drain Charge ^c	Q _{gd}		-	6.2	-		
Gate Resistance	Rg	f = 1 MHz	-	2.7	-	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	13	-		
Rise Time ^c	t _r	$V_{DD} = 20 \text{ V}, \text{ I}_{D} = 10 \text{ A}, \text{ R}_{g} = 3 \Omega$	-	8	-	- ns	
Turn-Off Delay Time ^c	t _{d(off)}	V _{GS} = 10 V	-	65	-		
Fall Time ^c	t _f		-	11	-		
Drain-Source Body Diode Ratings and	Characterist	ics ^b (T _C = 25 °C)					
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C	-	-	55	А	
Pulsed Current	I _{SM}		-	-	220	А	
Forward Voltage ^a	V _{SD}	I _F = 1 A, V _{GS} = 0 V	-	-	1.2	V	
Reverse Recovery Time	t _{rr}	I _F = 10 A, di/dt = 100 A/μs	-	38	-	ns	
Reverse Recovery Charge Q _{rr}		$r_{\rm F} = 10$ A, u/ul - 100 A/µS	-	29	-	nC	

Notes

a. Pulse test; pulse width \leq 400 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those in dicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended pe riods may affect device reliability.

P-Channel Electrical Character	istics (T _C =	= 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	L TEST CONDITIONS		TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V_{DS} $V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$		- 40	-	-	V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1	-	- 3	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 10 V$	-	-	± 100	nA	
Zara Cata Valtaga Drain Current	I _{DSS}	$V_{DS} = -40 V, V_{GS} = 0 V$	1		- 1		
Zero Gate Voltage Drain Current		V_{DS} =-32V, V_{GS} = 0 V, T_{J} = 55 °C	-	-	- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 52	-	-	А	
Drain-Source On-State Resistance ^a	P	V_{GS} = - 10 V, I _D = - 10 A	-	9	13	mΩ	
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 8 A	-	14	18		
Forward Transconductance a	g fs	V _{DS} = - 5 V, I _D = - 10 A	-	31	-	S	
Dynamic ^b	•	· · · · · · · · · · · · · · · · · · ·		•			
Input Capacitance	C _{iss}		-	3170	-	pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = -20 V$, f = 1 MHz	-	270	-		
Reverse Transfer Capacitance	C _{rss}		-	241	-		
Total Gate Charge ^c	Qg		-	47	-	nC	
Gate-Source Charge ^c	Q _{gs}	V_{DS} = - 20 V, V_{GS} = - 10 V, I_D = - 10 A	-	5.5	-		
Gate-Drain Charge ^c	Q _{gd}		-	9	-		
Gate Resistance	Rg	f = 1 MHz	-	10	-	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	12.5	-		
Rise Time ^c	tr	$V_{DD} = -20 V, R_{q} = 3 \Omega,$	-	28	-	- ns	
Turn-Off Delay Time ^c	t _{d(off)}	ID = - 10 A , VGs = - 10 V	-	46	-		
Fall Time ^c	t _f		-	15	-		
Drain-Source Body Diode Ratings and	Characterist	ics ^b (T _C = 25 °C)					
Continuous Source-Drain Diode Current	۱ _S	_S T _C = 25 °C		-	- 52	А	
Pulsed Current	I _{SM}		-	-	- 200	А	
Forward Voltage ^a	V _{SD}	I _F = - 1 A, V _{GS} = 0 V	-	-	-1.2	V	
Reverse Recovery Time	t _{rr}	I _F = - 10 A, di/dt = 100 A/µs	-	47	-	ns	
Reverse Recovery Charge	rse Recovery Charge Q _{rr}		-	32	-	nC	

Notes

a. Pulse test; pulse width \leq 400 µs, duty cycle \leq 2 %.

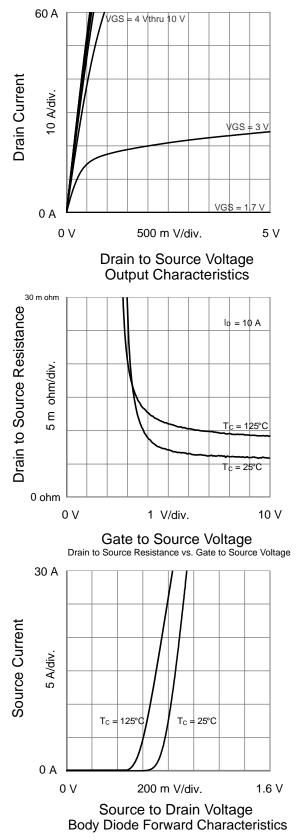
b. Guaranteed by design, not su bject to production testing.

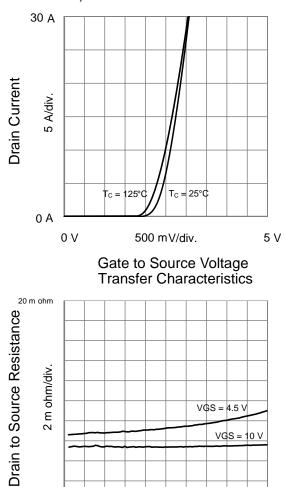
c. Independent of operating temperature.

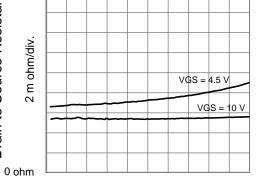
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N-CHANNEL TYPICAL CHARACTERISTICS (25°C, unless otherwise noted)

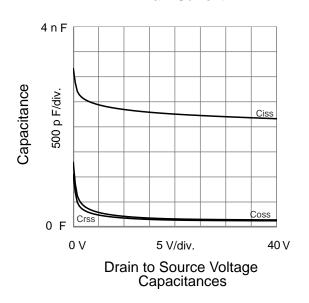






0 A

5 A/div. **Drain Current**



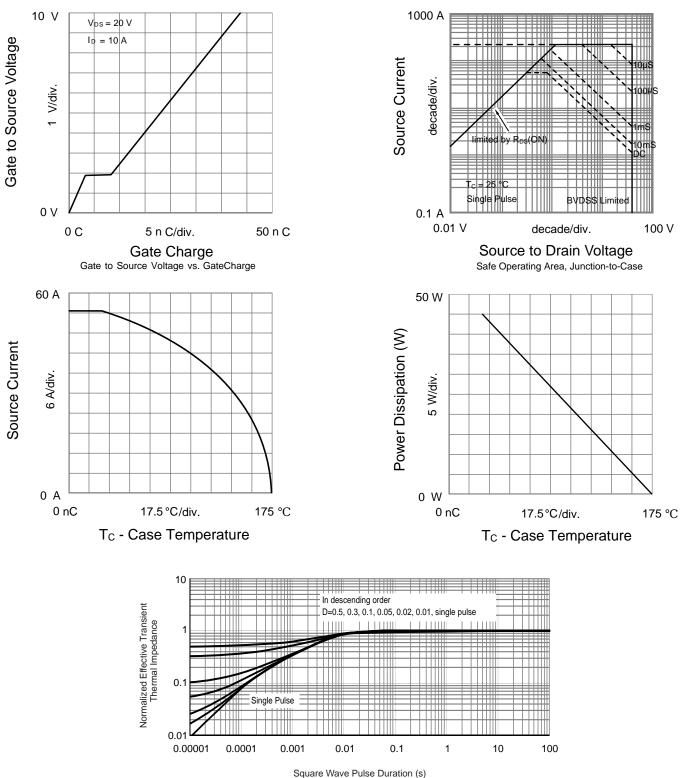
50 A



DTQ6D402

N-CHANNEL TYPICAL CHARACTERISTICS (25°C, unless otherwise noted)

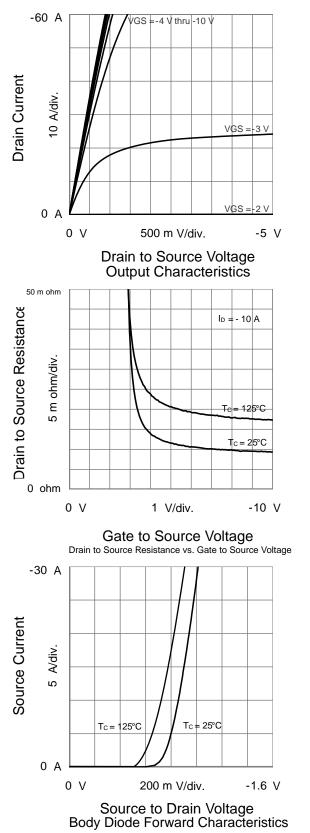
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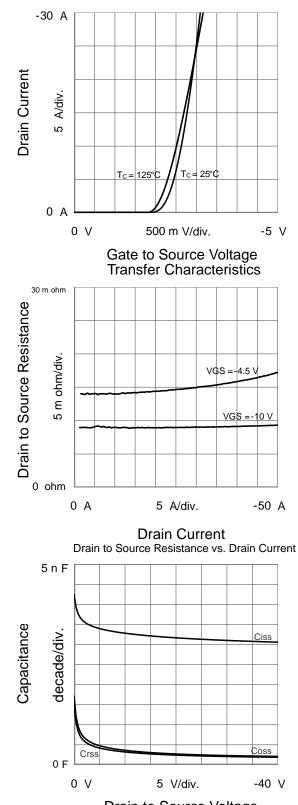


Normalized Thermal Transient Impedance, Junction-to-Case



P-CHANNEL TYPICAL CHARACTERISTICS (25°C, unless otherwise noted)

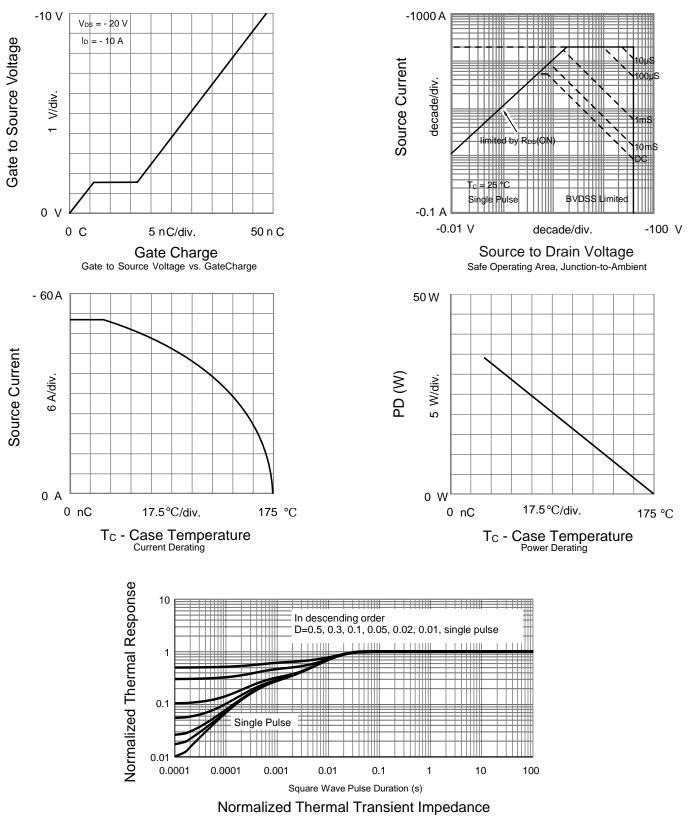




Drain to Source Voltage Capacitances



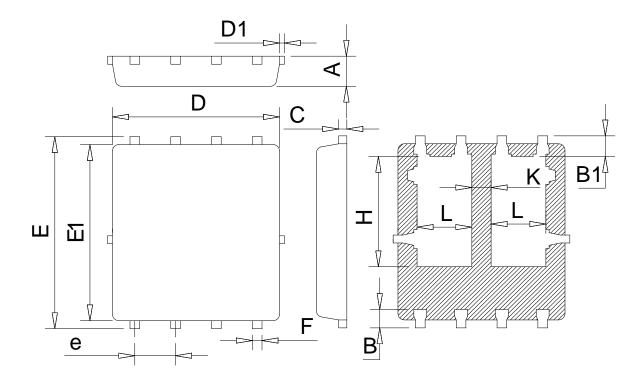
N-CHANNEL TYPICAL CHARACTERISTICS (25°C, unless otherwise noted)





DFN5X6-8L-D PACKAGE OUTLINE

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COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

Symbol	Min	Тур	Max
A	0.85	0.95	1.05
В	0.46	0.58	0.73
B1	0.52	0.65	0.78
С	0.18	0.254	0.32
D	4.70	5.20	5.50
D1	-	-	0.18
E	5.75	6.05	6.35
E1	5.35	5.65	5.85
е	1.20	1.27	1.50
F	0.20	0.40	0.50
Н	3.20	3.47	3.80
L	1.35	1.70	2.10
K	0.35	0.60	1.00



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